ABSTRACT OF THE DISCLOSURE

A surface mounting device comprising: multiple transfers being moved in the X and Y axis directions by an X-Y gantry installed on a base frame and supplying a printed circuit board(PCB) for mounting parts or loading the discharged PCB by a head unit for sucking parts supplied from a parts supply unit and mounting the sucked parts on the PCB and multiple conveyers installed to be moved horizontally in a predetermined direction at a predetermined position on the base frame for carrying the PCB supplied from the multiple transfers to a parts mounting work position and discharging the same to the multiple transfers when the mounting of the parts is finished.